Pb Free Plating Product

ISSUED DATE :2005/06/27
REVISED DATE :

GJ09N20

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

BV_{DSS}	200V
$R_{DS(ON)}$	380mΩ
I_D	8.6A

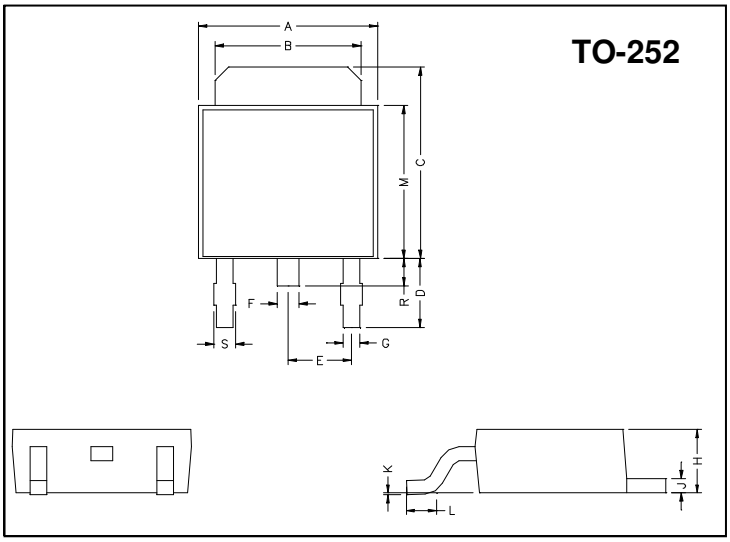
Description

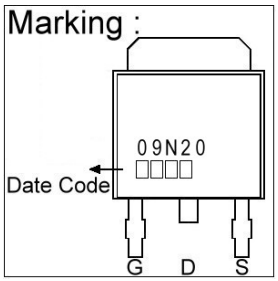
The GJ09N20 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.
The TO-252 package is universally preferred for all commercial-industrial surface mount applications at power dissipation levels to approximately 50 watts.

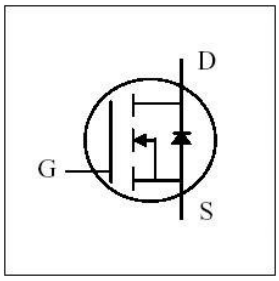
Features

*Simple Drive Requirement
*Lower On-resistance
*Fast Switching Characteristic

Package Dimensions







REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	6.40	6.80	G	0.50	0.70
B	5.20	5.50	H	2.20	2.40
C	6.80	7.20	J	0.45	0.55
D	2.40	3.00	K	0	0.15
E	2.30 REF.		L	0.90	1.50
F	0.70	0.90	M	5.40	5.80
S	0.60	0.90	R	0.80	1.20

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	200	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current, V_{GS}@10V	I_D @Tc=25℃	8.6	A
Continuous Drain Current, V_{GS}@10V	I_D @Tc=100℃	5.5	A
Pulsed Drain Current[1]	I_{DM}	36	A
Total Power Dissipation	P_D @Tc=25℃	69	W
Linear Derating Factor		0.55	W/℃
Single Pulse Avalanche Energy[2]	E_{AS}	40	mJ
Avalanche Current	I_{AR}	8.6	A
Operating Junction and Storage Temperature Range	Tj, Tstg	-55 ~ +150	℃

Thermal Data

Parameter		Symbol	Value	Unit
Thermal Resistance Junction-case	Max.	Rthj-c	1.8	℃/W
Thermal Resistance Junction-ambient	Max.	Rthj-a	110	℃/W

Electrical Characteristics (Tj = 25℃ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV_{DSS}	200	-	-	V	V_{GS}=0, I_D=1mA
Breakdown Voltage Temperature Coefficient	$\triangle BV_{DSS}/\triangle Tj$	-	0.24	-	V/℃	Reference to 25℃, I_D=1mA
Gate Threshold Voltage	$V_{GS(th)}$	2.0	-	4.0	V	V_{DS}=V_{GS}, I_D=250uA
Forward Transconductance	g_{fs}	-	3.7	-	S	V_{DS}=10V, I_D=5A
Gate-Source Leakage Current	I_{GSS}	-	-	±100	nA	V_{GS}= ±30V
Drain-Source Leakage Current(Tj=25℃)	I_{DSS}	-	-	10	uA	V_{DS}=200V, V_{GS}=0
Drain-Source Leakage Current(Tj=150℃)		-	-	100	uA	V_{DS}=160V, V_{GS}=0
Static Drain-Source On-Resistance	$R_{DS(ON)}$	-	-	380	mΩ	V_{GS}=10V, I_D=5A
Total Gate Charge[3]	Q_g	-	23	37	nC	I_D=8.6A V_{DS}=160V V_{GS}=10V
Gate-Source Charge	Q_{gs}	-	4	-		
Gate-Drain (“Miller”) Change	Q_{gd}	-	13	-		
Turn-on Delay Time[3]	$T_{d(on)}$	-	12	-	ns	V_{DD}=100V I_D=8.6A V_{GS}=10V R_G=10Ω R_D=11.6Ω
Rise Time	T_r	-	25	-		
Turn-off Delay Time	$T_{d(off)}$	-	36	-		
Fall Time	T_f	-	16	-		
Input Capacitance	C_{iss}	-	500	800	pF	V_{GS}=0V V_{DS}=25V f=1.0MHz
Output Capacitance	C_{oss}	-	90	-		
Reverse Transfer Capacitance	C_{rss}	-	40	-		

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage[3]	V_{SD}	-	-	1.3	V	I_S=8.6A, V_{GS}=0V
Reverse Recovery Time	T_{rr}	-	225	-	ns	I_S=8.6A, V_{GS}=0V dI/dt=100A/μs
Reverse Recovery Charge	Q_{rr}	-	2260	-	nC	

Notes: 1. Pulse width limited by safe operating area.

2. Staring Tj=25℃, V_{DD}=50V, L=1mH, R_G=25Ω, I_{AS}=8.6A.

3. Pulse width≦300us, duty cycle≦2%.

Characteristics Curve

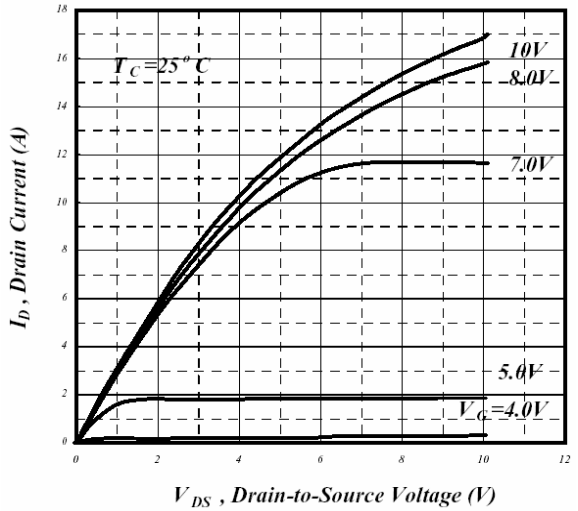


Fig 1. Typical Output Characteristics

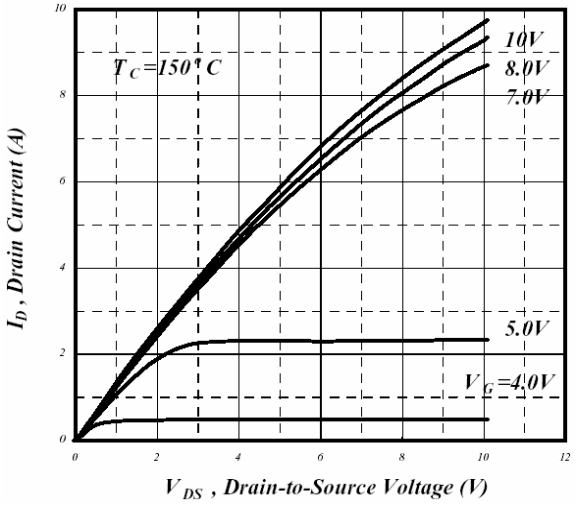


Fig 2. Typical Output Characteristics

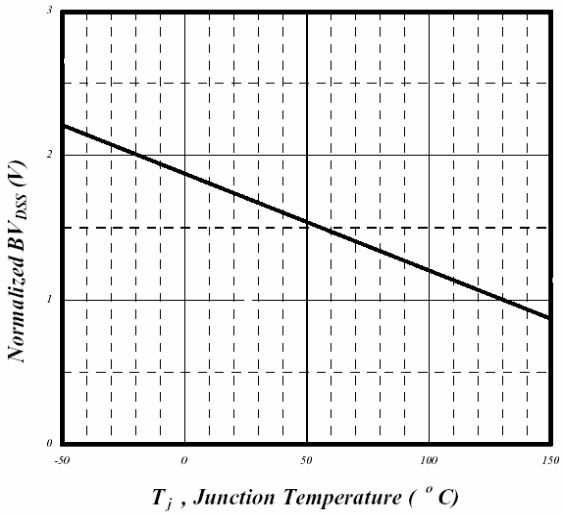


Fig 3. Normalized BVDSS v.s. Junction Temperature

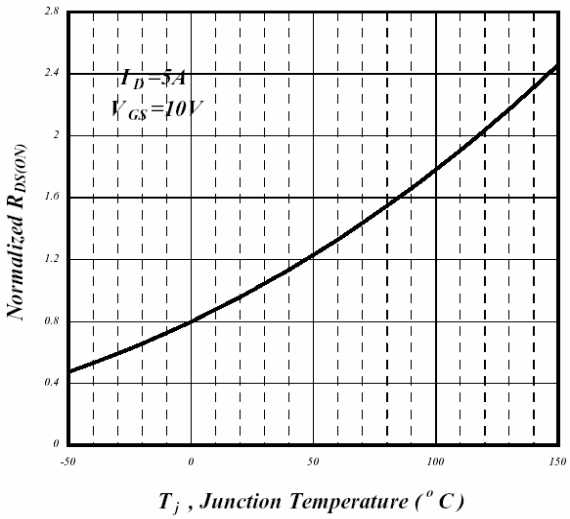


Fig 4. Normalized On-Resistance v.s. Junction Temperature

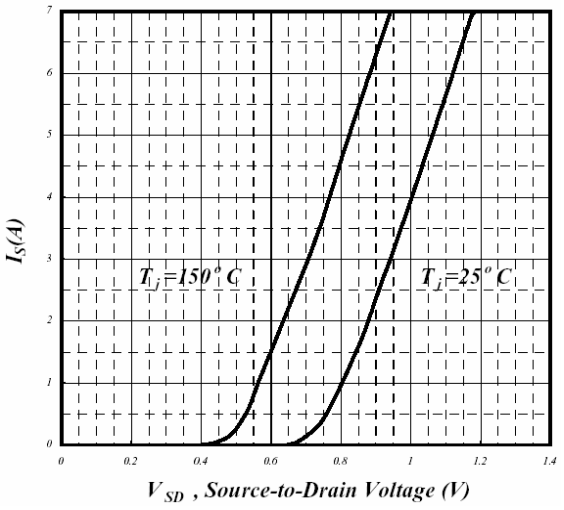


Fig 5. Forward Characteristics of Reverse Diode

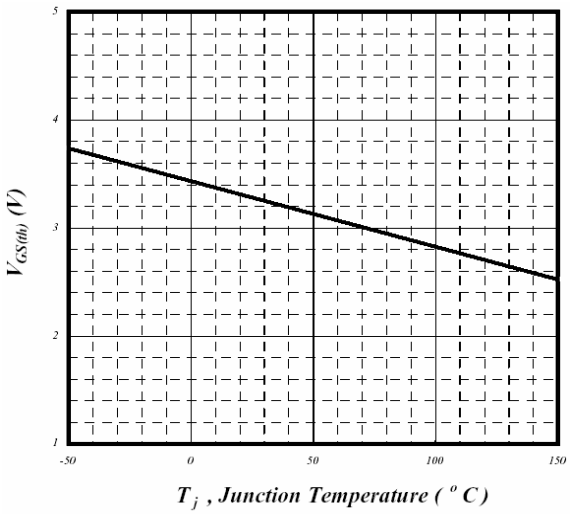


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

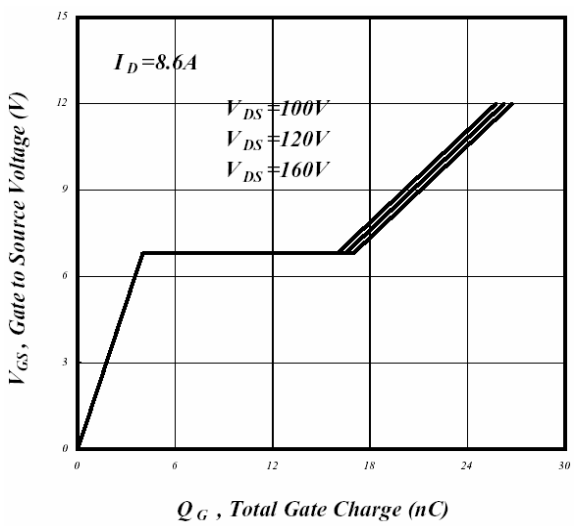


Fig 7. Gate Charge Characteristics

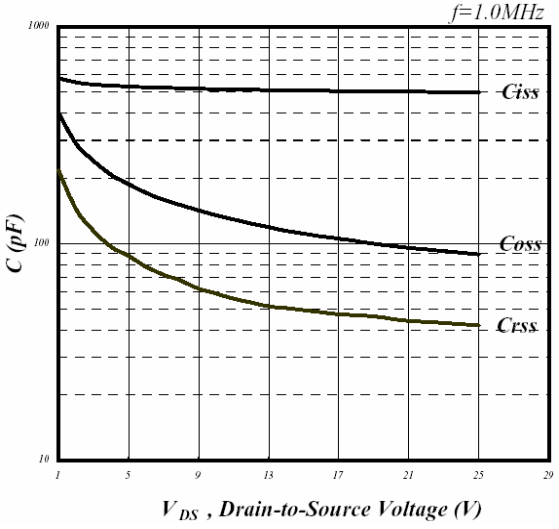


Fig 8. Typical Capacitance Characteristics

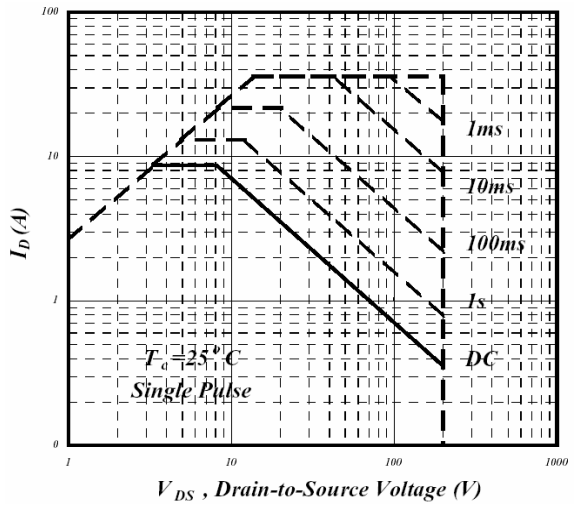


Fig 9. Maximum Safe Operating Area

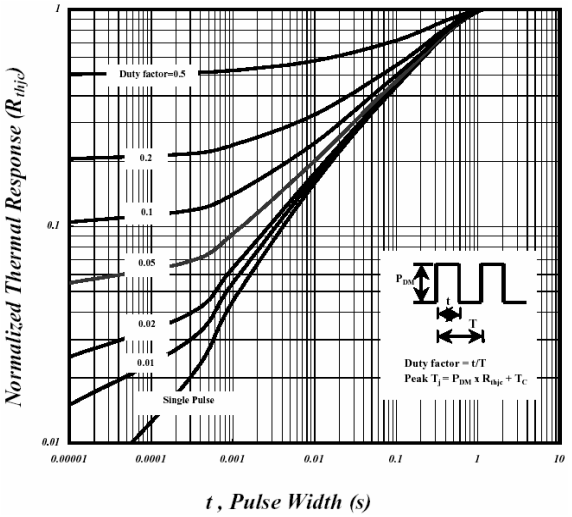


Fig 10. Effective Transient Thermal Impedance

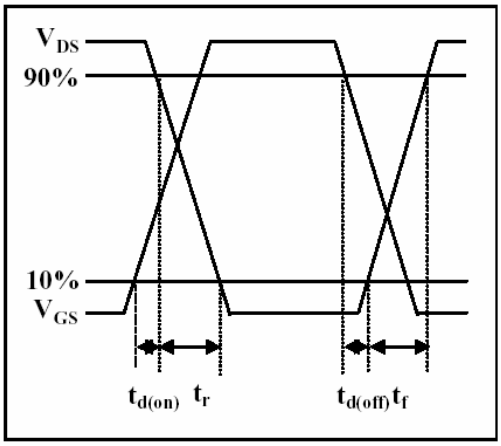


Fig 11. Switching Time Waveform

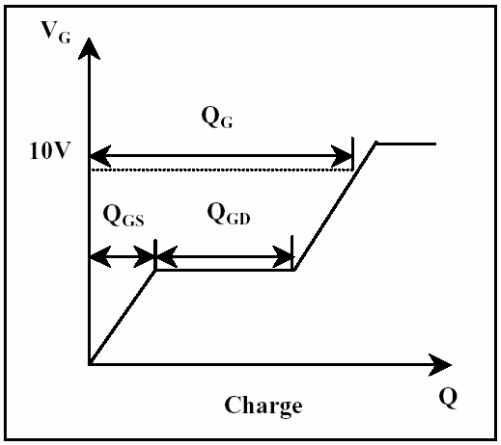


Fig 12. Gate Charge Waveform

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